**PATENT ASSIGNMENT COVER SHEET**

**SUBMISSION TYPE:** RESUBMISSION  
**NATURE OF CONVEYANCE:** MERGER  
**EFFECTIVE DATE:** 04/01/2014  
**RESUBMIT DOCUMENT ID:** 504365146

### CONVEYING PARTY DATA

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<th>Name</th>
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<tr>
<td>RENESAS NORTHERN JAPAN SEMICONDUCTOR, INC.</td>
<td>04/01/2014</td>
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### RECEIVING PARTY DATA

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<thead>
<tr>
<th>Name</th>
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<tr>
<td>RENESAS SEMICONDUCTOR KYUSHU YAMAGUCHI CO., LTD.</td>
<td></td>
</tr>
<tr>
<td>Street Address</td>
<td>1-1, 1-CHOME, YAHATA, MINAMI-KU, KUMAMOTO-SHI</td>
</tr>
<tr>
<td>City</td>
<td>KUMAMOTO</td>
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Fax Number: (703)684-1157

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 7036841120
Email: escotti@mmiplaw.com
Correspondent Name: MATTINGLY & MALUR, PC
Address Line 1: 1800 DIAGONAL ROAD
Address Line 2: SUITE 210
Address Line 4: ALEXANDRIA, VIRGINIA 22314

ATTORNEY DOCKET NUMBER: T&A-GEN/Z-1704(USMA)ABCD1
NAME OF SUBMITTER: JOHN R. MATTINGLY
SIGNATURE: /John R. Mattingly/
DATE SIGNED: 06/05/2017

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**PATENT ASSIGNMENT COVER SHEET**

Electronic Version v1.1  
Stylesheet Version v1.2

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Fax Number: (703)684-1157  
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Email: escott@mnmplaw.com  
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Address Line 1: 1800 DEGONAL ROAD  
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Address Line 4: ALEXANDRIA, VIRGINIA 22314

**ATTORNEY DOCKET NUMBER:** T&A-GEN/Z-1704(USMA)ABCD1

**NAME OF SUBMITTER:** JOHN R. MATTINGLY

Signature: /John R. Mattingly/

Date: 05/12/2017

Total Attachments: 6
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**RECEIPT INFORMATION**

EPAS ID: PAT4411838  
Receipt Date: 05/12/2017
STATEMENT

I, the undersigned, a citizen of Japan, state as follows:

1. THAT I am well acquainted with the Japanese Language and the English language, and

2. THAT the attached is a true, accurate and partial translation into the English language of the following document:

   Register of Corporate Record of Merger from Renesas Northern Japan Semiconductor, Inc. to Renesas Semiconductor Kyushu Yamaguchi Co., Ltd.

   As indicated in the translation, the date of registration of the document and the seal are shown at the bottom of the last page of the document.

AND I, the undersigned, state that the facts set forth above are true and correct.

Shoko TSUTSUI
Signature

[Printed Name]

June 5, 2017
Date
CERTIFICATE OF
ALL OF THE CLOSED PARTICULARS OF BUSINESS REGISTRATION

14-1, Kyobashi 2-chome, Chuo-ku, Tokyo, Japan
Renesas Northern Japan Semiconductor, Inc.
Registration Number: 4400-01-004556

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<tr>
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<th>Renesas Northern Japan Semiconductor, Inc.</th>
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<tr>
<td>Head Office</td>
<td>14-1, Kyobashi 2-chome, Chuo-ku, Tokyo, Japan</td>
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<td>Method of Public Notice</td>
<td>To be made by electronic public notice. <a href="http://www.kitasemi.renesas.com/corporate/publicnotice">http://www.kitasemi.renesas.com/corporate/publicnotice</a> However, when it is not notified appropriately due to the accident or any other unavoidable reason, it is given in the form of official gazettes.</td>
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<td>Date of Incorporation</td>
<td>May 30, 1970</td>
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<tr>
<th>Company Split</th>
<th>Split to Renesas Kofu Semiconductor, Inc. with its address at 4617, Nishiyahata, Kai-shi, Yamanashi, Japan on April 1, 2014. Registered on April 3, 2014</th>
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<tr>
<td>Matters regarding Company with Auditors</td>
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Serial No. ß 471339  "Underlined portion indicates a deletion."
Matters regarding Company with Board of Company Accounting Auditors

Company with Board of Company Accounting Auditors

Matters regarding Registration Records

Relocation of Head Office from 11-3, Shinbashii 5-chome, Minato-ku, Tokyo Japan on October 1, 2013
Registered on October 1, 2013

Dissolution by merger to Renesas Semiconductor Kyushu
Yamaguchi Co., Ltd. with its address at 1-1, 1-chome, Yahata, Minami-ku, Kumamoto-shi, Kumamoto, Japan on April 1, 2014
Registered on April 18, 2014
Closed on April 18, 2014

This is to certify that the foregoing document is all of the closed particulars of the Company recorded in the Register of Business Registration.

Dated this 26th day of November 2014.

Takasaki Branch Office of Maebashi Local Legal Affairs Bureau
Registrar
Masayuki TANAKA (Seal)

Serial No. 7 471339 *Underlined portion indicates a deletion.
閉鎖事項全部証明書

株式会社ルネサス北日本セミコンダクタ

商号：株式会社ルネサス北日本セミコンダクタ

住所：東京都中央区京橋二丁目14番1号

公告をする方法：当会社の公告方法は、電子公告とする。
http://www.kitasemi.renesas.com/corporate/publicnotice
ただし、事故その他のやむを得ない事由により電子公告をすることが出来ない場合は、官報に掲載する方法とする。

会社成立の年月日：昭和45年5月30日

目的：1. 半導体素子、集積回路等の電子部品の研究、開発、設計、製造及び販売その他の処分
2. 電気機器、電子機器、通信機器の部品及び材料の研究、開発、設計、製造、販売及び販売その他の処分
3. 前各号に関連するソフトウェアの開発、製造、販売及び販売
4. 前各号に付帯または関連する一切の業務

発行可能株式総数：1920万株

発行済株式の総数：664万8000株

資本金の額：5億5000万円

株式の譲渡制限に関する規定：当会社の株式の譲渡には、株主総会の承認を要する。

役員に関する事項

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<tr>
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<td>平成25年6月21日就任</td>
</tr>
<tr>
<td>取締役</td>
<td>兼中 哲也</td>
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整理番号：テ471339

* 下線のあるものは株主事項であることを示す。
<table>
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<tbody>
<tr>
<td>番地</td>
<td>山形県米沢市北陽町大沢3の3274</td>
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</table>

会社分割
- 平成26年4月1日山形県甲府市西八幡4617番地のネス有限公司セミコンダクター株式会社に分割
- 平成26年4月1日茨城県ひたちなか市見沼730番地株式会社レクサス九州セミコンダクターに分割
- 平成26年4月1日山口県柳井市南禅寺三丁目1番1号株式会社レクサス九州セミコンダクターを合併
- 平成26年4月1日山形県米沢市大沢3091番地の6株式会社を合併
- 平成26年4月1日北海道二海郡八雲町東289番地の12株式会社を合併
- 平成26年4月1日滋賀県甲府市大津町大津272番地10株式会社レクサス九州セミコンダクターを合併

取締役会設置会社に関する事項
- 取締役会設置会社

監査役設置会社に関する事項
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<tr>
<th>会計監査人設置会社に関する事項</th>
<th>会計監査人設置会社</th>
</tr>
</thead>
<tbody>
<tr>
<td>登記記録に関する事項</td>
<td>平成25年10月1日東京都港区新橋五丁目11番3号から本店移転</td>
</tr>
<tr>
<td></td>
<td>平成25年10月1日登記</td>
</tr>
<tr>
<td></td>
<td>平成26年4月1日築本市南区八幡一丁目1番1号ルネサスセミコンダクタ九州山口株式会社に合併し解散</td>
</tr>
<tr>
<td></td>
<td>平成26年4月18日登記</td>
</tr>
<tr>
<td></td>
<td>平成26年4月18日閉鎖</td>
</tr>
</tbody>
</table>

これは登記簿に記録されている閉鎖された事項の全部であることを証明した書類である。
(東京法務局管轄)

平成26年11月26日
前橋地方検察庁高崎支局
登記官

整理番号 471339 ＊ 決済のあたるものは廃消事項であることを示す。